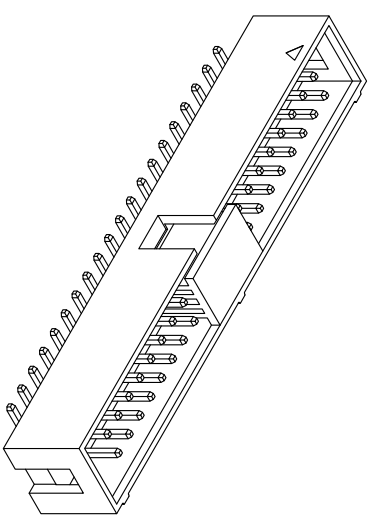
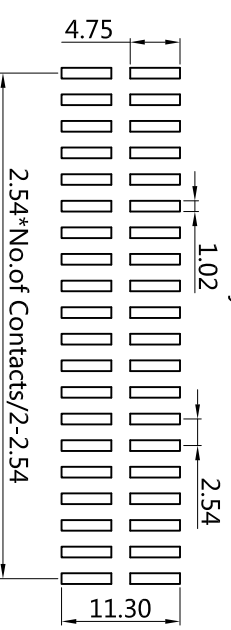


PIN	A (mm)	B (mm)
6P	15.24	5.08
8P	17.78	7.62
10P	20.32	10.16
12P	22.86	12.70
14P	25.40	15.24
16P	27.94	17.78
18P	30.48	20.32
20P	33.02	22.86
22P	35.56	25.40
24P	38.10	27.94
26P	40.64	30.48
28P	43.18	33.02
30P	45.72	35.56
32P	48.26	38.10
34P	50.80	40.64
36P	53.34	43.18
40P	58.42	48.26
44P	63.50	53.34
50P	71.12	60.96
60P	83.82	73.66
64P	88.90	78.74

Above number of producible pins



Recommended P.C. Board
SMD Layout



(RoHS Compliant) **BH11 X - XX D0 BK X 000 E**

1. Insulator material: 5. Contact Plated:

- A=PBT N=PA6T T=Matte Tin over Nickel
- P=PA9T W=Matte Tin over nickel 150μ"
- Y=Bright Tin over Nickel
- 3. Tail Style: F=Gold Flash, Matte Tin 100μ"
- D0=SMT A=Gold 3μ" , Matte Tin 100μ"
- 4. Color: C = ordinary gold plating L=Gold 10μ" , Matte Tin 100μ"
- BK=Black D = Gold 5μ" M=Gold 15μ" , Matte Tin 100μ"
- V=Gold 30μ" Matte Tin 100μ"

6. Special Options

- D=Gold 5μ"
- I=Gold 1μ"
- G=Gold 10μ"
- J=Gold 10μ"
- L=Gold 15μ"
- M=Gold 15μ"
- U=Gold 30μ"
- V=Gold 30μ"

7. Packing:

- A=Bag
- B=Tube
- C=Tray
- E=Cap+Reel
- F=Cap+tube
- G=Cap+tray
- H=Cap+bag
- N=Tap&reel



东莞市震升电子有限公司
DONG GUAN ZHEN SHENG ELECTRONICS CO., LTD

BOM	1: BH11X-XXBKHX0C4	PART NO.	BH11X-XXD0BKX000E
	2: SQ0.64-13.36-X-C12	DRAWING NO	ZS-00022-J
	3: HIN-CAP-HO-C2	DRAWN BY	Deng jin quan
TEL:0769-85305015 FAX:0769-85845060		APPROVAL BY	Chen xiao guang

			X	.XX	.XXX
			±0.30	±0.20	±0.1
			EDITION:A1	ITEM: BH11	SCALE:1:1
			2022-11-30	UNIT:M:M	

1 2 3 4 5 6 7 8